TE Internal #: 2013289-2

SO DIMM Sockets, Double Data Rate (DDR) 3, Stack Height .205 in [5.2 mm], Right Angle Module Orientation, Surface Mount, Cable-

to-Board, 204 Position

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Connectors > Socket Connectors > Memory Sockets > SO DIMM Sockets











DRAM Type: Double Data Rate (DDR) 3

Stack Height: 5.2 mm [.205 in]

Module Orientation: Right Angle

PCB Mounting Style: Surface Mount

Connector System: Cable-to-Board

Features

Product Type Features

DRAM Type	Double Data Rate (DDR) 3
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Product Type	Socket

Configuration Features

Number of Bays	2
Center Key	Offset Left
Number of Keys	1
Module Orientation	Right Angle
Number of Positions	204
Number of Rows	2
Keying	Standard

Electrical Characteristics



DRAM Voltage	1.5 V
Signal Characteristics	
SGRAM Voltage	1.5 V
Body Features	
Ejector Location	Both Ends
Latch Material	Stainless Steel
Latch Plating Material	Tin
Module Key Type	SGRAM
Ejector Type	Locking
Connector Profile	Standard
Contact Features	
Socket Style	SO DIMM
PCB Contact Termination Area Plating Material	Gold
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.254 μm[10 μin]
Contact Current Rating (Max)	.5 A
Socket Type	Memory Card
Termination Features	
Insertion Style	Cam-In
Mechanical Attachment	
PCB Mount Retention	With
PCB Mount Retention Type	Solder Peg
PCB Mounting Style	Surface Mount
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	.6 mm[.024 in]
Housing Color	Black
Housing Material	High Temperature Thermoplastic
Dimensions	
Stack Height	5.2 mm[.205 in]
Row-to-Row Spacing	8.2 mm[.322 in]



Usage Conditions

Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
Circuit Application	Power
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Semi-Hard Tray Assembly
Packaging Quantity	20
Other	
Comment	With floating peg.

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



Compatible Parts



Customers Also Bought

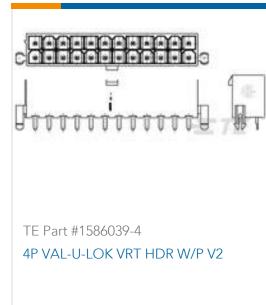




















Documents

Product Drawings

SEMI-HARD TRAY DDR3 204P 5.2H STD Au0.25

English

CAD Files

3D PDF

3D



Customer View Model

ENG_CVM_CVM_2013289-2_B.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2013289-2_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2013289-2_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

Datasheets & Catalog Pages

DDR3 DIMM Sockets Flyer 6-1773454-7 05/09

English

6-1773457-3_DDR3_DIMM_SOCKETS

Product Specifications

Product Specification

English

Product Environmental Compliance

TE Material Declaration

English